

EE143 – Fall 2016

Microfabrication Technologies

Prof. Ming C. Wu
wu@eecs.berkeley.edu
511 Sutardja Dai Hall (SDH)



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Course Information (1)

- **Lecture**
 - 11:10 to 12:30 pm Tuesday, Thursday
 - Room: Cory 241
- **Instructor:**
 - Professor Ming C. Wu
 - 511 Sutardja Dai Hall (SDH), wu@eecs.berkeley.edu
 - Office hours: tba
 - Best way to communicate: Email
- **GSIs:**
 - Mark Hettick, Head GSI
 - Korok Chatterjee
 - Dominic E. Labanowski (10 hour GSI)
 - Thomas Rembert



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Course Information (2)

- **Prerequisites:**
 - EE16A/B and Physics 7B or equivalent
- **Course Description**
 - EE143 teaches the fundamentals of integrated-circuit (IC) fabrication, giving the student a basic understanding of IC processes and the effect of processing choices on device performance.
 - Students learn to use process simulation tools and also fabricate and characterize devices in the laboratory.
 - This lecture part will cover the processing techniques and design methodologies of microfabrication.



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Slide 0-3



Course Information (3)

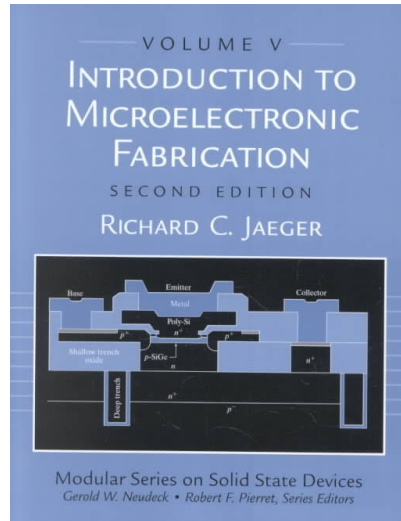
- In addition to transistors and IC's, you will fabricate simple MEMS (micro-electro-mechanical systems) structures
- The second part of the course will cover process simulation, layout design rules, MOS, IC, and MEMS process integration.
- The laboratory part of the course will provide students opportunities to have hands-on experience to fabricate and characterize a NMOS chip with simple MEMS components.



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Textbook



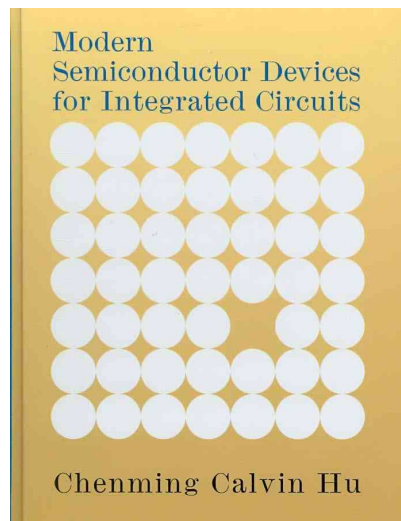
- **Introduction To Microelectronic Fabrication (2nd edition)**
 - R. C. Jaeger
 - Prentice Hall
- **Minimum reading**
 - Assigned sections in syllabus
- **Best to read the relevant sections before lecture**
 - Enables meaningful in class discussions



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Reference Book for MOS Devices



- **Modern Semiconductor Devices for Integrated Circuits**
 - Prof. Chenming Hu
 - Prentice Hall, 2010
- **Available online**
 - <https://people.eecs.berkeley.edu/~hu/Book-Chapters-and-Lecture-Slides-download.html>



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Course Web Sites

- **Open website**
 - General course info, lecture notes, Labs, HW problems
 - <http://www-inst.eecs.berkeley.edu/~ee143/fa16/>
- **bcourses**
 - <https://bcourses.berkeley.edu/>
 - Grades (check frequently, and inform your GSI if you find any discrepancy)
 - HW solutions
 - Exam solutions
- **Piazza**
 - Discussions



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Grades

- **Laboratory: 35%**
 - Includes quizzes, lab work, and reports
 - You must complete all labs to pass the course!
- **Homework: 5%**
 - Lowest score will be dropped from grade calculation
 - (You can miss one HW without impacting your grade)
- **Midterms: 15% x 2 = 30%**
 - Closed book. One sheet of notes allowed.
- **Final Exam: 30%**
 - Closed book. 3 sheets of notes allowed.
- **Cheating will result in automatic Fail**



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Laboratory Requirements (35% of the total grade)

- **Lab attendance: 10 pts (5% of the total grade).**
 - Each absence results in -2 pts. Each lateness results in -1 pt.
 - Students receiving a lab attendance grade of 0 pts or less will automatically fail the course.
 - Make-up lab sections are allowed (student will be attending a different lab section for that week), however, prior written request must be submitted to Professor Wu. Students attending pre-approved make-up sections will not lose points.
 - Note that being unprepared, unwilling to participate in the lab activities, and/or not following the safety procedures will result in losing lab attendance points.
- **Lab Quizzes: (5% of the total grade).**
 - They will be given often (unannounced) at the beginning of each lab.
- **Lab Report 1: 100 pts (15% of the total grade).**
- **Lab Report 2: 100 pts (10% of the total grade).**
 - Note for both Lab Reports: For every day that it is turned in late, you will lose 20 pts. We will not collect after 4 days past the deadline.



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Midterm & Final Dates

- **Midterm 1:**
 - 10/4/16 (Tue) in class
- **Midterm 2:**
 - 11/1/2015 (Tue) in class
- **Final Exam:**
 - 12/14/16 (Wed), 8-11 am
- **General rule: no early or late exams**
 - Rare exceptions, e.g., presenting a paper in a conference
 - Need to inform the instructor well in advance



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Course Structure – Lab and Lecture

- You learn the theories in class; you practice them in lab
- You are going to make:
 - Resistors, diodes, MOS-cap
 - Bipolar transistor, MOS-transistor, ...
 - Some MEMS structures, like beams, ...
- By the end of the semester, you should have learned
 - Basic lab techniques
 - How to operate some fabrication equipment
 - How to characterize the devices you made



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Lecture Schedule

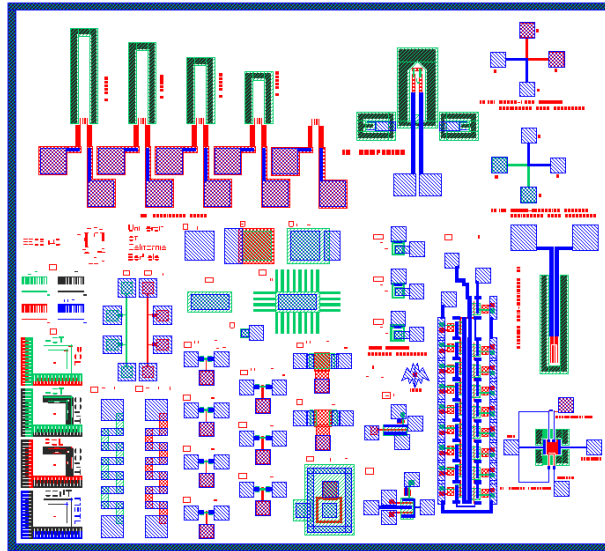
- Introduction to Materials and Processing (1-2 weeks)
- Photolithography (2 weeks)
- Etching (1 week)
- Oxidation (1 week)
- Deposition (1 week)
- Diffusion (1 week)
- Ion Implantation (1 week)
- Metallization/CMP (1 week)
- Simulation/Layout
- Process Integration (throughout)
- Introduction to Devices (2 weeks)



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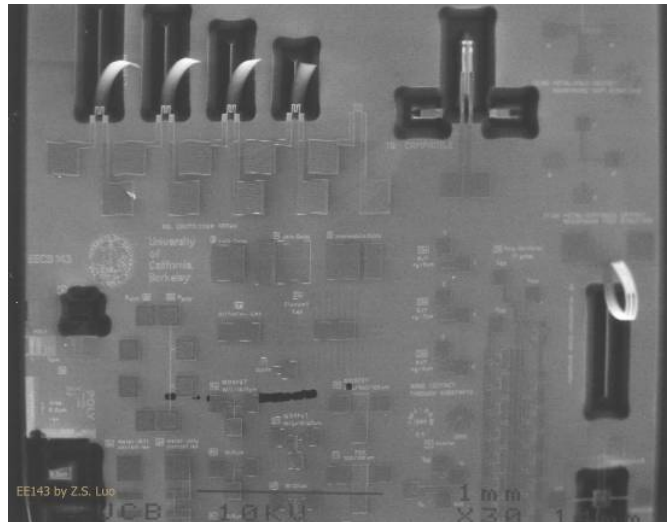
The EE143 Chip



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This is How Your Chip Looks Like

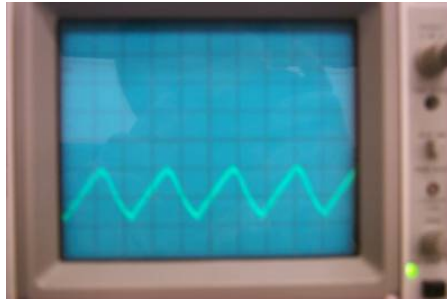


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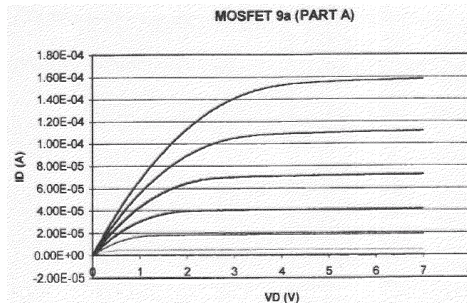


Measure Your Devices

- The resulting structures may be characterized electrically or mechanically



17-stage Ring Oscillator



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Laboratory Information

- Lab starts in the week of Aug. 29
- We do our best to limit lab size to 6 students; as a result, your telebears enrollment is not a guarantee of being assigned to a lab.
- **You MUST send an email to Professor Wu (wu@eecs.berkeley.edu) by this Friday 10am including the following information:**
 - Email Subject: EE143 Lab
 - 1) Full Name
 - 2) Major
 - 3) Year (Jr., Sr., Grad student, etc.)
 - 4) Rank list of preferred lab sections in descending order of preference (i.e., 1st choice, 2nd choice...)
 - 5) List of any lab sections that you CANNOT attend
- Failure to send an email by this Friday may result in you being dropped from the course, even if you are registered on telebears.
- Final lab assignment will be sent to you via email. **PLEASE ENSURE THAT YOUR EMAIL ADDRESS ON TELEBEARS IS CORRECT, SINCE THIS WILL BE USED FOR OFFICIAL CORRESPONDENCE!!!**

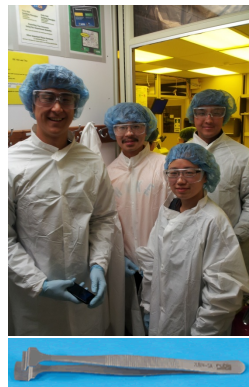


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Lab Cleanliness

- Fully gowned before entering cleanroom
 - Hair net + lab coat + glove + shoe net + safety goggles
- Do NOT touch chemicals / equipment with bare hands
- Always handle wafers with tweezers and trays (unless told otherwise)
- Wash hands before and after entering the lab (why??)
 - Before: so as not to contaminate wafers or equipment
 - After: avoid chemicals being ingested
- 3rd week, GSIs will demonstrate how to clean masks
- 4th week, GSIs will demonstrate how to piranha-clean wafers



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Lab Safety

- First week is on Lab Safety (week of Aug. 29)
- Mandatory Lab attendance required
- You will have a lab orientation session, and will have to pass a safety quiz before you are officially enrolled in this course.
- You MUST attend the lab session to which you are assigned.



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Lab Safety

- **Do NOT enter the lab when GSI aren't present**
- **Know all the emergency exits**
 - Ask GSIs to show you
- **Know where to find the MSDS**
 - Under the whiteboard in characterization room
- **Know where to find the closest water sources, shower, eye wash, sink**
- **Always ASK if you are not sure what to do!**
 - Do NOT try things out without permission
- **NO eating, drinking, playing, etc. inside the lab**
- **Things in the lab can be dangerous if not carefully handled. Be sure to respect the chemicals.**



Chemical Handling

- **Wear protective gear when handling corrosive chemicals**
 - Face shield, chemical apron, chemical gloves, respirator if necessary
- **Check glove for holes**
- **Check pH of unknown spillage, label everything**
- **Corrosive chemicals: H_2SO_4 , HF, aluminum etch, TMAH**
- **Wash and rinse the exposed body parts with water for > 15 mins**
- **Add acids to water, not the other way around**
- **Handle wet chemicals only at sinks, acid on right, others on left side**

Chemical Handling (cont'd)

- **HF:**
 - be very very careful
 - HF will penetrate your body and attack your skeletal system; once you feel it, it is already eating your bones!!!
 - apply calcium gluconate if exposure is suspected
 - use only plastic beakers for HF (why??)
- **H₂SO₄:**
 - very painful, severely burns
 - add H₂O₂ to H₂SO₄ to prepare piranha
 - do not carry the beaker around after mixing (HOT!!)
 - use only glass beakers for piranha (why??)
- **Chemicals used in the lab are often harmful. Don't breathe and avoid exposure if possible.**
- **Use Teflon-ware when handling wafers in acids. Be careful, those Teflon tweezers do not hold the wafers very well!!**



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Chemical Disposal

- **Organic chemicals are discarded in designated containers**
- **NOTE: in this lab, photoresist (PR) is also dumped down the drain.**
- **Do NOT mix organic wastes with acids (why??)**
 - Can cause fire or even explosion
- **Do NOT mix acids and bases**



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Lab Floor Plan

Note: Not drawn to scale

